		07-07-2006					
•	OMB No. 0651-0027 (exp 6/30/2008)			U.S. Department of Commerce Patent and Trademark Office Attorney Docket No. 09812.0802 Attorney Customer Number: 22,852			
	To the Director of the U.S. Patents and	103270404		ned original docum	ents or copy t	hereof.	
0	۱۶. Name of conveying party : Hideki NOMA		2.	Name and address of receiving party:			
0	i		Name:	SONY CORP	ORATION		
30-06	Additional name(s) of conveying party(ies) attached? Yes No		Internal	rnal Address: 7-35 KITASHINAGAWA 6-CHOME, SHINAGAWA-KU, TOKYO, JAPAN			
,,,	3. Nature of conveyance/Execution Date: Execution Date: June 14, 2006		Street A	ddress:			
P		☐ Merger	City:			0 _	
	☐ Security Agreement	☐ Change of Name	State:		Zip Code:	6 89.	
	☐ Joint Research Agreement					37 08	
	Government Interest Assignment			Additional name(s) & Address(es) attached?			
	☐ Executive Order 9424, Confirmatory License						
	Other			☐ Yes	⊠ No		
	4. Application number(s) or patent number(s):						
	A. Patent Application Number(s):		В.	Patent Number(s):		
		Additional numbers attached?	☐ Yes	⊠ No			
	5. Name and address of to who document should be mailed	om correspondence concerning :	6.	Total number of involved: 1	applications	and registrations	
	Name: Mr. Ernest F. Chapman		7.	Total fee (37 CF)	R 3.41): \$40		
07/0	5/2006 DEMMANU1 00000006 1147 73 99			Authorized to be			
	4 AC:8021 40.00 DP			☐ Authorized to be charged to deposit account☐ Enclosed (Please charge deficiency to deposit			
				account) None required (government interest not affecting title)			
	Internal Address: FINNEGAN, HEND & DUNNER, L.L.P.	DERSON, FARABOW, GARRETT	8. Paym	nent Information			
	Street Address: 901 New York Ave		1	a. Credit Card	Last 4 Number Expiration Da	ers ate	
	City: Washington, D.C.		1	b. Deposit Accou	-	06-0916	
	State: Zip:	20001-4413		Authorized Us	er Name		
	8. Statement and signature.						
	To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.						
		Danie W.	Hel		June 30, 20	06	
	David W. Hill	Signa	ature		Da	ate	
	Total number of pages including cover sheet, attachments and documents: 2						

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, PO box 1450, Alexandria, VA 22313-1450

S06P0829US00

ASSIGNMENT

Docket Number: 09812.0802

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in CONTENTS DATA REPRODUCTION APPARATUS AND CONTENTS DATA REPRODUCTION METHOD

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application in the spaces that follow: Serial Number:	this application to insert the serial number and filing date of, Filing Date:
This assignment executed on the dates indicated below.	
Hideki NOMA Name of first or sole inventor	Execution date of U.S. Patent Application
Kanagawa, Japan	
Residence of first or sole inventor Nideki Roma	June 14,200 6
Signature of first or sole inventor	Date of this assignment

PATENT REEL: 018062 FRAME: 0249

RECORDED: 06/30/2006